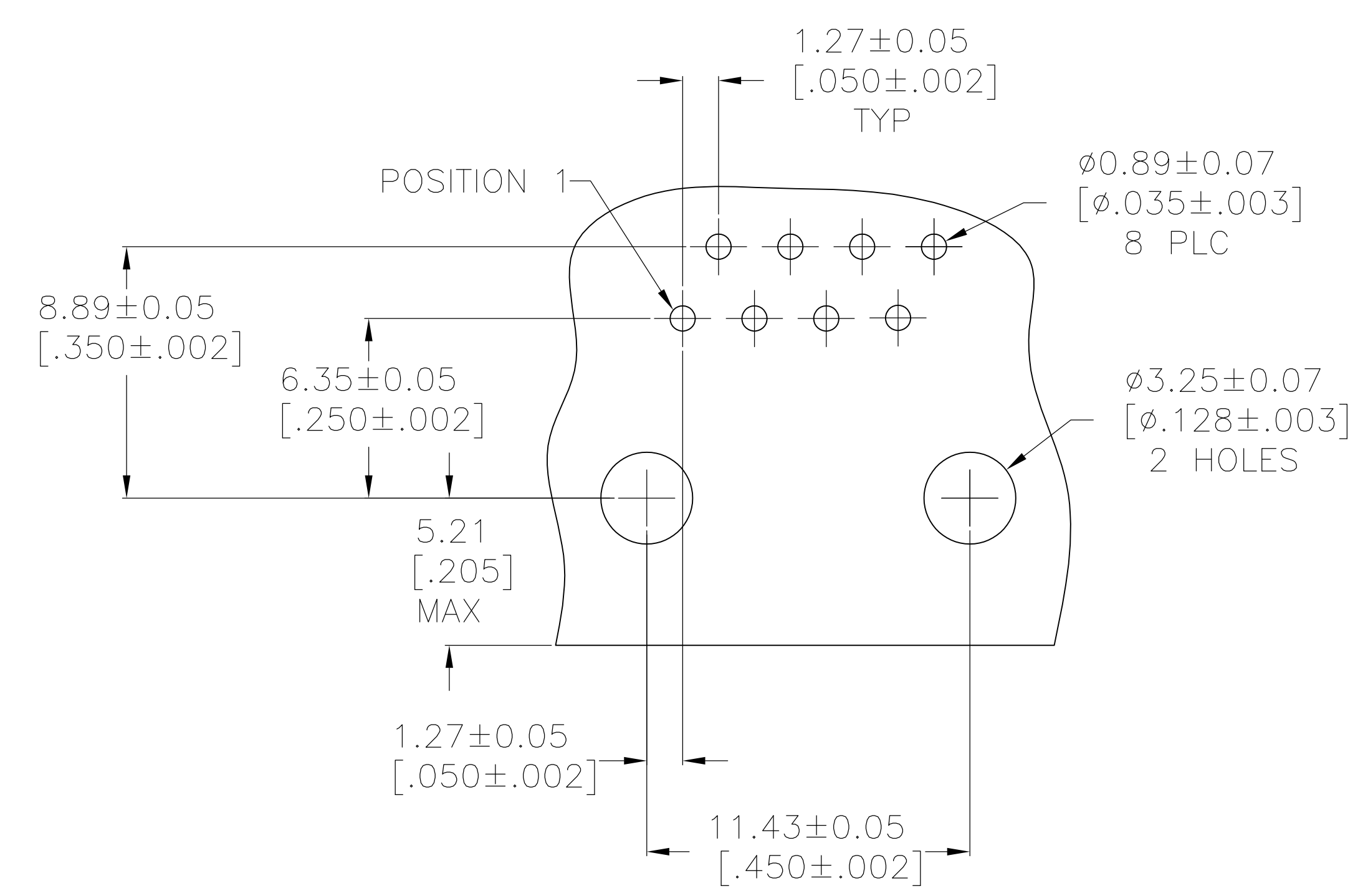


- MATERIAL: HOUSING - PBT POLYESTER, COLOR: BLACK
TERMINAL - 0.35 [.014] THICK PHOSPHOR BRONZE PLATED WITH 1.27µm [.000050] THICK HARD GOLD IN LOCALIZED GOLD PLATE AREA AND 2.03µm [.000080] THICK MATTE TIN IN SOLDER AREA OVER 1.27µm [.000050] THICK NICKEL UNDERPLATE.
- CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68 AND REA BULLETIN 345-81, PE-76 SPECIFICATION FOR MODULAR TELEPHONE HARDWARE.
- BULK PACKAGED IN A TRAY.



RECOMMENDED PRINTED CIRCUIT BOARD LAYOUT COMPONENT SIDE SHOWN

5555162-1
PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DIN T. SPRINKLE/L.A. MAYER 22APR2005		STE TE Connectivity	
DIMENSIONS: mm [INCHES]		CHK J. WESTMAN 22APR2005		NAME	
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD S. FLICKINGER 22APR2005		PRODUCT SPEC	
0 PLC ± -		APPLICATION SPEC		MODULAR JACK ASSEMBLY, 8 POSITION, LOW PROFILE, RIGHT ANGLE, WITH PANEL STOPS	
1 PLC ± -		SIZE		108-1163	
2 PLC ± -		CAGE CODE		114-2048	
3 PLC ± 0.13(.005)		DRAWING NO		00779	
4 PLC ± -		WEIGHT		5555162	
ANGLES ± -		CUSTOMER DRAWING		SCALE 4:1 SHEET 1 OF 1 REV D1	